

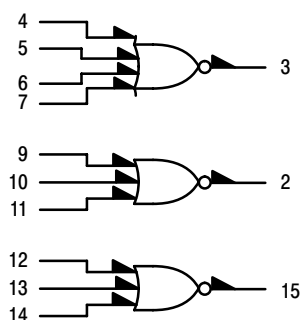
# MC10106

## Triple 4-3-3-Input NOR Gate

The MC10106 is a triple 4-3-3 input NOR gate.

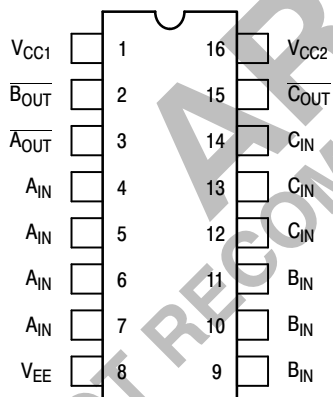
- $P_D = 30 \text{ mW typ/gate (No Load)}$
- $t_{pd} = 2.0 \text{ ns typ}$
- $t_r, t_f = 2.0 \text{ ns typ (20\%–80\%)}$

### LOGIC DIAGRAM



$V_{CC1} = \text{PIN } 1$   
 $V_{CC2} = \text{PIN } 16$   
 $V_{EE} = \text{PIN } 8$

### DIP PIN ASSIGNMENT



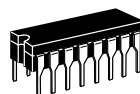
Pin assignment is for Dual-In-Line Package.  
 For PLCC pin assignment, see the Pin Conversion Tables on page 18  
 of the ON Semiconductor MECL Data Book (DL122/D).



**ON Semiconductor**

<http://onsemi.com>

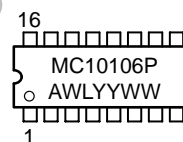
### MARKING DIAGRAMS



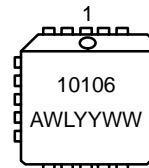
**CDIP-16**  
**L SUFFIX**  
**CASE 620**



**PDIP-16**  
**P SUFFIX**  
**CASE 648**



**PLCC-20**  
**FN SUFFIX**  
**CASE 775**



A = Assembly Location  
 WL = Wafer Lot  
 YY = Year  
 WW = Work Week

### ORDERING INFORMATION

Device	Package	Shipping
MC10106L	CDIP-16	25 Units / Rail
MC10106P	PDIP-16	25 Units / Rail
MC10106FN	PLCC-20	46 Units / Rail

## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Pin Under Test	Test Limits							Unit
			-30°C		+25°C			+85°C		
			Min	Max	Min	Typ	Max	Min	Max	
Power Supply Drain Current	I <sub>E</sub>	8		23		17	21		23	mAdc
Input Current	I <sub>inH</sub>	4		425			265		265	μAdc
	I <sub>inL</sub>	4	0.5		0.5			0.3		μAdc
Output Voltage      Logic 1	V <sub>OH</sub>	3 2	-1.060 -1.060	-0.890 -0.890	-0.960 -0.960		-0.810 -0.810	-0.890 -0.890	-0.700 -0.700	Vdc
Output Voltage      Logic 0	V <sub>OL</sub>	3 2	-1.890 -1.890	-1.675 -1.675	-1.850 -1.850		-1.650 -1.650	-1.825 -1.825	-1.615 -1.615	Vdc
Threshold Voltage    Logic 1	V <sub>OHA</sub>	3 2	-1.080 -1.080		-0.980 -0.980			-0.910 -0.910		Vdc
Threshold Voltage    Logic 0	V <sub>OLA</sub>	3 2		-1.655 -1.655			-1.630 -1.630		-1.595 -1.595	Vdc
Switching Times (50Ω Load)										ns
Propagation Delay	t <sub>4+3-</sub> t <sub>4-3+</sub>	3 3	1.0 1.0	3.1 3.1	1.0 1.0	2.0 2.0	2.9 2.9	1.0 1.0	3.3 3.3	
Rise Time            (20 to 80%)	t <sub>3+</sub>	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	
Fall Time            (20 to 80%)	t <sub>3-</sub>	3	1.1	3.6	1.1	2.0	3.3	1.1	3.7	

## ELECTRICAL CHARACTERISTICS (continued)

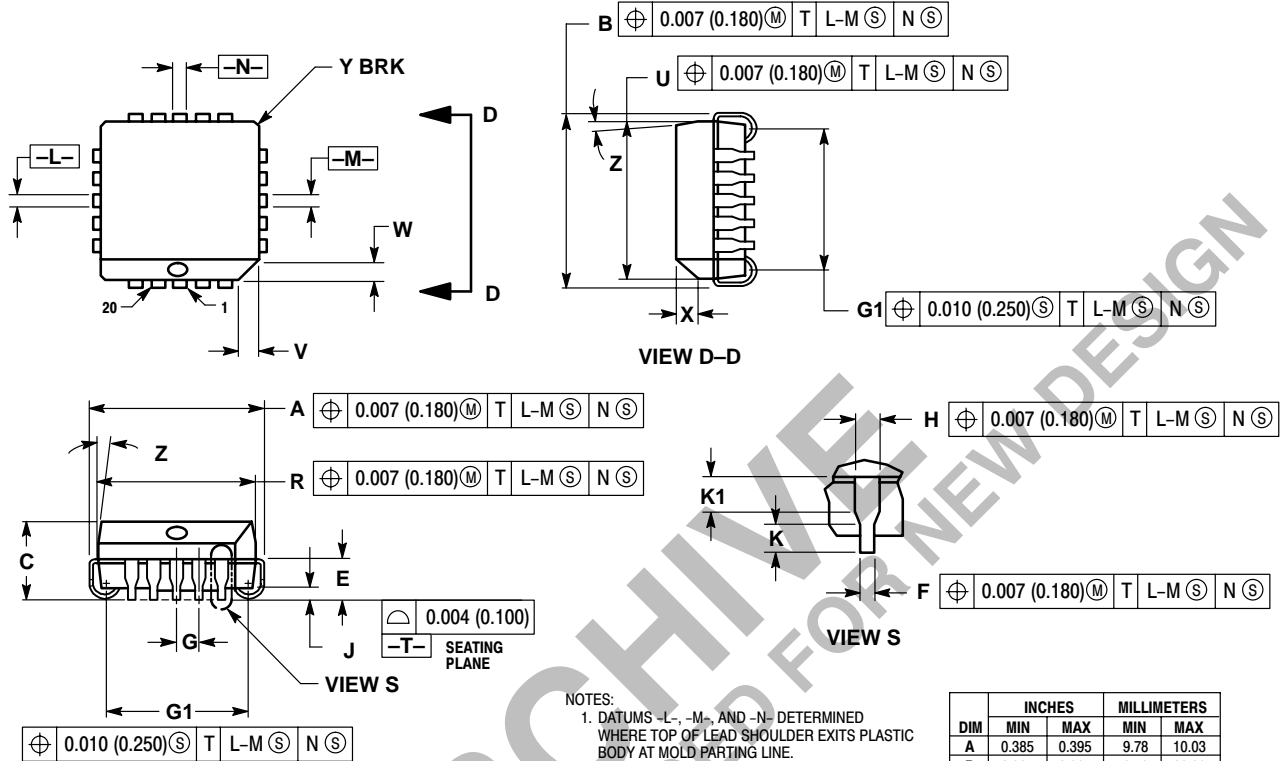
@ Test Temperature			TEST VOLTAGE VALUES (Volts)					(V <sub>CC</sub> ) Gnd	
			V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmx</sub>	V <sub>EE</sub>		
			−30°C	−0.890	−1.890	−1.205	−1.500		−5.2
			+25°C	−0.810	−1.850	−1.105	−1.475		−5.2
			+85°C	−0.700	−1.825	−1.035	−1.440		−5.2
Characteristic	Symbol	Pin Under Test	TEST VOLTAGE APPLIED TO PINS LISTED BELOW						
			V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmx</sub>	V <sub>EE</sub>		
Power Supply Drain Current	I <sub>E</sub>	8					8	1, 16	
Input Current	I <sub>inH</sub>	4	4				8	1, 16	
	I <sub>inL</sub>	4		4			8	1, 16	
Output Voltage      Logic 1	V <sub>OH</sub>	3					8	1, 16	
		2					8	1, 16	
Output Voltage      Logic 0	V <sub>OL</sub>	3	4				8	1, 16	
		2	9				8	1, 16	
Threshold Voltage      Logic 1	V <sub>OHA</sub>	3				4	8	1, 16	
		2				9	8	1, 16	
Threshold Voltage      Logic 0	V <sub>OLA</sub>	3			4		8	1, 16	
		2			9		8	1, 16	
Switching Times      (50Ω Load)					Pulse In	Pulse Out	−3.2 V	+2.0 V	
Propagation Delay	t <sub>4+3−</sub>	3			4	3	8	1, 16	
	t <sub>4−3+</sub>	3			4	3	8	1, 16	
Rise Time      (20 to 80%)	t <sub>3+</sub>	3			4	3	8	1, 16	
Fall Time      (20 to 80%)	t <sub>3−</sub>	3			4	3	8	1, 16	

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

# MC10106

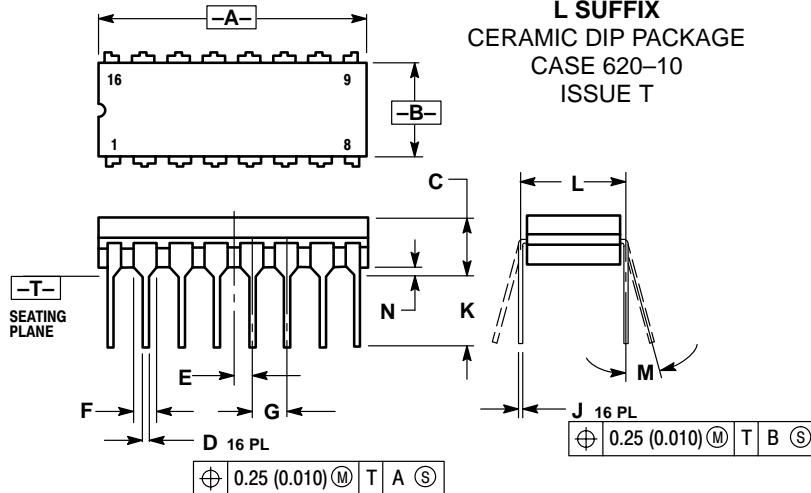
## PACKAGE DIMENSIONS

PLCC-20  
FN SUFFIX  
PLASTIC PLCC PACKAGE  
CASE 775-02  
ISSUE C



# MC10106

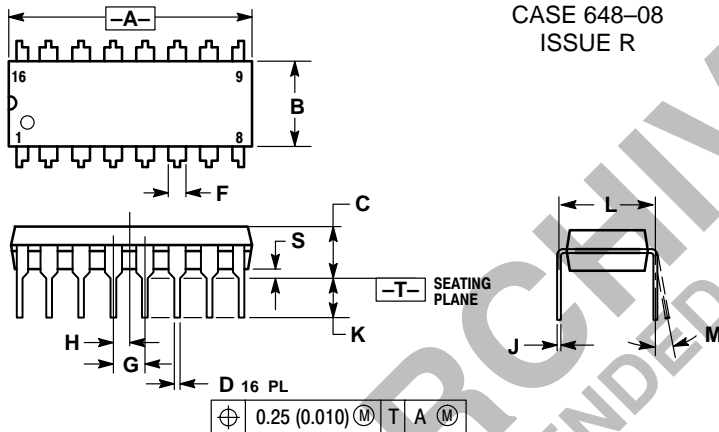
## CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620-10 ISSUE T



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
  4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.


DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	---	0.200	---	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0°	15°	0°	15°
N	0.020	0.040	0.51	1.01

## PDIP-16 P SUFFIX PLASTIC DIP PACKAGE CASE 648-08 ISSUE R



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
  4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  5. ROUNDED CORNERS OPTIONAL.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0°	10°	0°	10°
S	0.020	0.040	0.51	1.01

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